

DFM600FXS12-A000

Fast Recovery Diode Module

DS5847-1.0 June 2005 (LN23947)

FEATURES

- Low Reverse Recovery Charge
- High Switching Speed
- Low Forward Voltage Drop
- Isolated Copper Base plate
- Dual Diodes Can be paralleled for 1200A Rating
- Lead Free construction

APPLICATIONS

- Chopper Diodes
- Boost and Buck Converters
- Free-wheel Circuits
- Snubber Circuit
- Resonant Converters
- Induction Heating
- Multi-level Switch Inverters

The DFM600FXS12-A000 is a dual 1200V, fast recovery diode (FRD) module. Designed for low power loss, the module is suitable for a variety of high voltage applications in motor drives and power conversion.

Fast switching times and low reverse recovery losses allow high frequency operation making the device suitable for the latest drive designs employing pwm and high frequency switching.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DFM600FXS12-A000

Note: When ordering, please use the whole part number.

KEY PARAMETERS

V _{RRM}		1200V
V _F	(typ)	1.9V
I _F	(max)	600A
I _{FM}	(max)	1200A

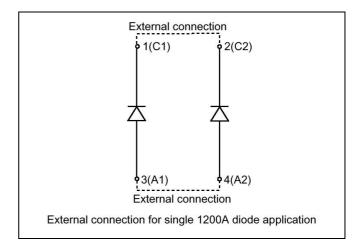


Fig. 1 Circuit diagram

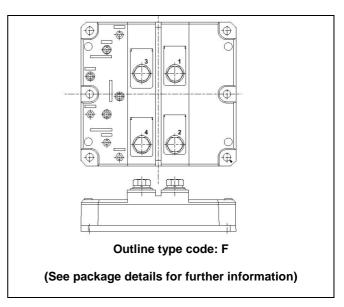


Fig. 2 Package

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures.



ABSOLUTE MAXIMUM RATINGS – PER ARM

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

Tcase = 25° C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V _{RRM}	Repetitive peak reverse voltage	T _{vj} = 125° C	1200	V
IF	Forward current (per arm)	DC, $T_{case} = 75^{\circ} C, T_{vj} = 125^{\circ} C$	600	А
I _{FM}	Max. forward current	$T_{case} = 110^{\circ} \text{ C}, t_{p} = 1 \text{ ms}$	1200	А
l ² t	I ² t value fuse current rating	$V_R = 0, t_P = 10ms, T_{vj} = 125^{\circ} C$	100	kA ² s
P _{max}	Maximum power dissipation	$T_{case} = 25^{\circ} C, T_{vj} = 125^{\circ} C$	2500	W
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	2500	V

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AI_2O_3
Baseplate material:	Copper
Creepage distance:	32mm
Clearance:	20mm
CTI (Critical Tracking Index):	175

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
R _{th(j-c)}	Thermal resistance – diode (per arm)	Continuous dissipation – junction to case	-	-	40	° C/kW
$R_{th(c-h)}$	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	° C/kW
Tj	Junction temperature	-	-	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
-	Screw torque	Mounting – M6	-	-	5	Nm
		Electrical connections – M8	-	-	10	Nm

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures



STATIC ELECTRICAL CHARACTERISTICS – PER ARM

$T_{case} = 25^{\circ} C$ unless stated otherwise.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
I _{RM}	Peak reverse current	$V_R = 1200V, T_{vj} = 125^{\circ} C$	-	-	10	mA
VF	Forward voltage	I _F = 600A	-	1.9	2.2	V
		$I_F = 600A, T_{vj} = 125^{\circ} C$	-	2.1	2.4	V
L _M	Inductance	-	-	20	-	nH

STATIC ELECTRICAL CHARACTERISTICS

T_{case} = 25° C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
L _M	Module Inductance (externally connected in parallel)	-	-	15	-	nH

DYNAMIC ELECTRICAL CHARACTERISTICS – PER ARM

T_{case} = 25° C unless stated otherwise.

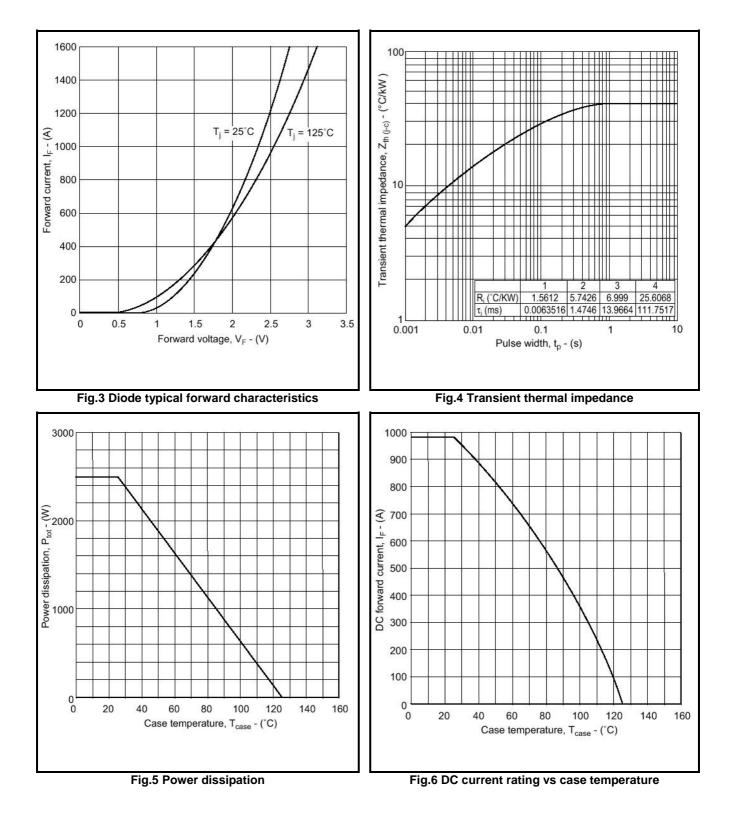
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Irr	Peak reverse recovery current	I _F = 600A,	-	400	-	А
Q _{rr}	Reverse recovery charge	dl _F /dt = 4500A/µs, V _R = 600V	-	100	-	μC
E _{rec}	Reverse recovery energy		-	40	-	mJ

$T_{case} = 125^{\circ}$ C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
l _{rr}	Peak reverse recovery current	I _F = 600A,	-	475	-	А
Qrr	Reverse recovery charge	dl _F /dt = 4200A/µs,	-	150	-	μC
E _{rec}	Reverse recovery energy	V _R = 600V	-	70	-	mJ



TYPICAL CHARACTERISTICS – PER ARM





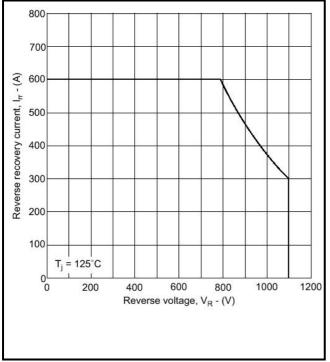


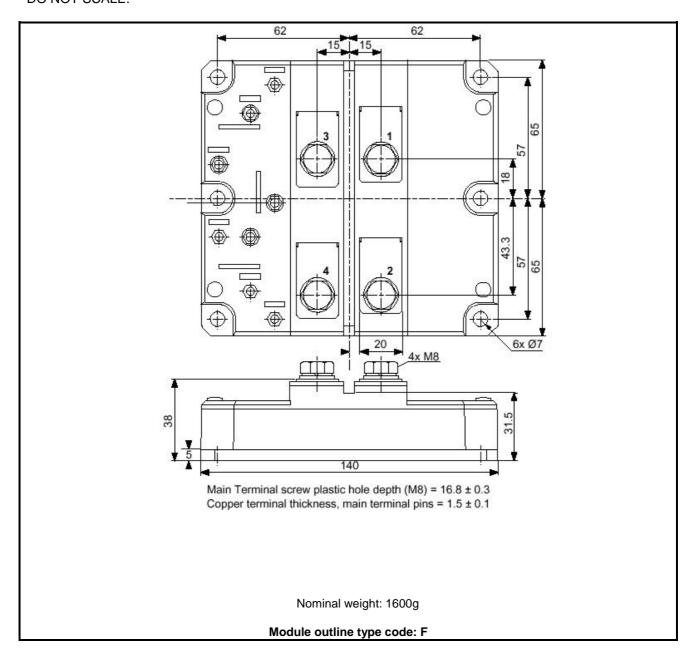
Fig.7 RBSOA

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PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink and clamping systems in line with advances in device voltages and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group offers high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the latest CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete Solution (PACs).

HEATSINKS

The Power Assembly group has its own proprietary range of extruded aluminium heatsinks which have been designed to optimise the performance of Dynex semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest sales representative or Customer Services.



http://www.dynexsemi.com

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Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

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No Annotation: The product parameters are fixed and the product is available to datasheet specification.

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